

DS4217-2.3

DSF11060SG

FAST RECOVERY DIODE

APPLICATIONS

■ Snubber Diode For GTO Circuits.

KEY PAR	AMETERS
V _{RRM}	6000V
F(AV)	400A
I _{FSM}	4200A
Q _r	700 μC
t _{rr}	6.0 μs

FEATURES

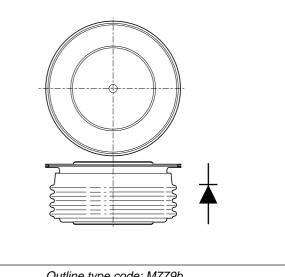
- Double Side Cooling.
- High Surge Capability.
- Low Recovery Charge.

VOLTAGE RATINGS

Type Number	Repetitive Peak Reverse Voltage V _{RRM} V	Conditions
DSF11060SG60	6000	$V_{RSM} = V_{RRM} + 100V$
DSF11060SG58	5800	
DSF11060SG56	5600	
DSF11060SG55	5500	

Lower voltage grades available.

CURRENT RATINGS



Outline type code: M779b. See package outlines for further information.

Symbol	Parameter	Conditions	Max.	Units		
Double Side Cooled						
I _{F(AV)}	Mean forward current	Half wave resistive load, $T_{case} = 65^{\circ}C$	400	А		
I _{F(RMS)}	RMS value	$T_{case} = 65^{\circ}C$	631	А		
١ _F	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	585	A		
Single Side Cooled (Anode side)						
I _{F(AV)}	Mean forward current	Half wave resistive load, $T_{case} = 65^{\circ}C$	265	A		
I _{F(RMS)}	RMS value	$T_{case} = 65^{\circ}C$	420	A		
I _F	Continuous (direct) forward current	$T_{case} = 65^{\circ}C$	365	A		

SURGE RATINGS

Symbol	Parameter	Conditions	Max.	Units
I _{FSM}	Surge (non-repetitive) forward current	10 ms half since with $0%$ V T = $150%$	4.2	kA
l ² t	I ² t for fusing	10ms half sine; with 0% V _{RRM.} T _j = 150°C	88 x 10 ³	A ² s
I _{FSM}	Surge (non-repetitive) forward current	10mc holf since with $50%$ V = T = $150%$	3.4	kA
l ² t	l ² t for fusing	10ms half sine; with 50% V_{RRM} , $T_j = 150^{\circ}C$	57.8 x 10 ³	A ² s

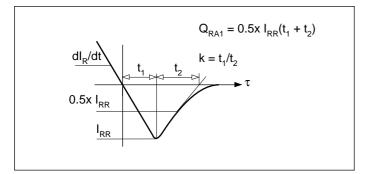
THERMAL AND MECHANICAL DATA

Symbol	Parameter	Conditions		Min.	Max.	Units
	R _{th(j-c)} Thermal resistance - junction to case	Double side cooled	dc	-	0.032	°C/W
R _{th(j-c)}			Anode dc	-	0.064	°C/W
	Single side cooled	Cathode dc	-	0.064	°C/W	
		Clamping force 12kN with mounting compound	Double side	-	0.008	°C/W
K _{th(c-h)}	R _{th(c-h)} Thermal resistance - case to heatsink		Single side	-	0.016	°C/W
T _{vj}	Virtual junction temperature	Forward (conducting)		-	135	°C
T _{stg}	Storage temperature range			-55	125	°C
-	Clamping force			10.8	13.2	kN

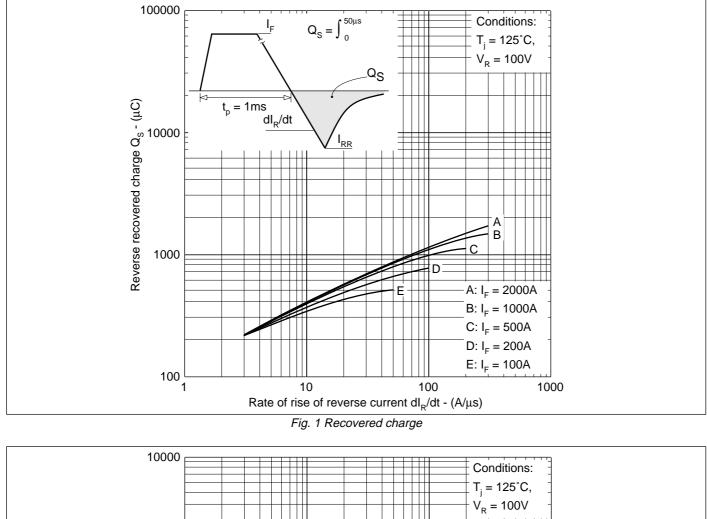
CHARACTERISTICS

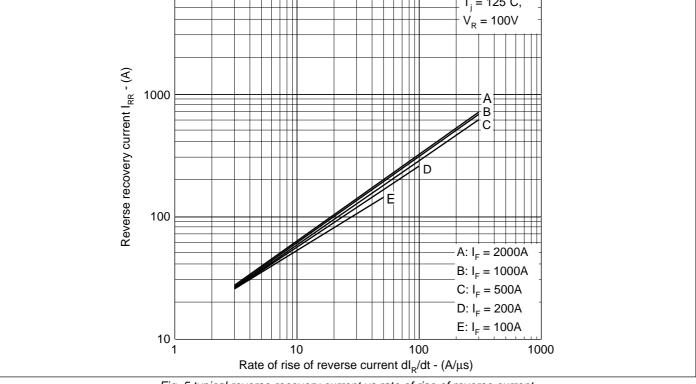
Symbol	Parameter	Conditions	Тур.	Max.	Units
V _{FM}	Forward voltage	At 600A peak, T _{case} = 25°C	-	3.8	V
I _{RRM}	Peak reverse current	At V_{RRM} , $T_{\text{case}} = 125^{\circ}\text{C}$	-	70	mA
t _{rr}	Reverse recovery time		6.0	-	μs
Q _{RA1}	Recovered charge (50% chord)	I _F = 1000A, di _{RR} /dt = 100A/μs	-	1000	μC
I _{RM}	Reverse recovery current	T _{case} = 125°C, V _R = 100V	350	-	А
к	Soft factor		1.7	-	-
V _{to}	Threshold voltage	At $T_{vj} = 125^{\circ}C$	-	1.5	V
r _T	Slope resistance	At $T_{vj} = 125^{\circ}C$	-	2.9	mΩ
V_{FRM}	Forward recovery voltage	di/dt = 1000A/µs, T _j = 100°C	-	400	V

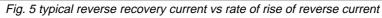
DEFINITION OF K FACTOR AND $\mathbf{Q}_{_{\mathrm{RA1}}}$



CURVES







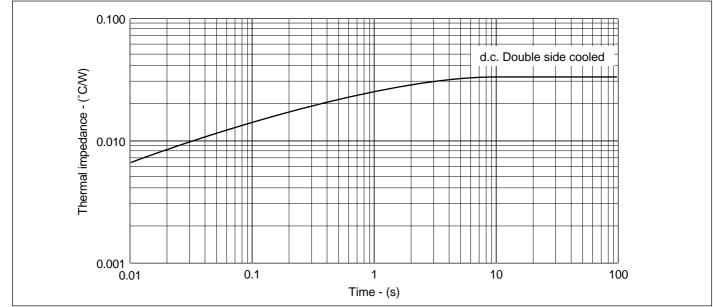
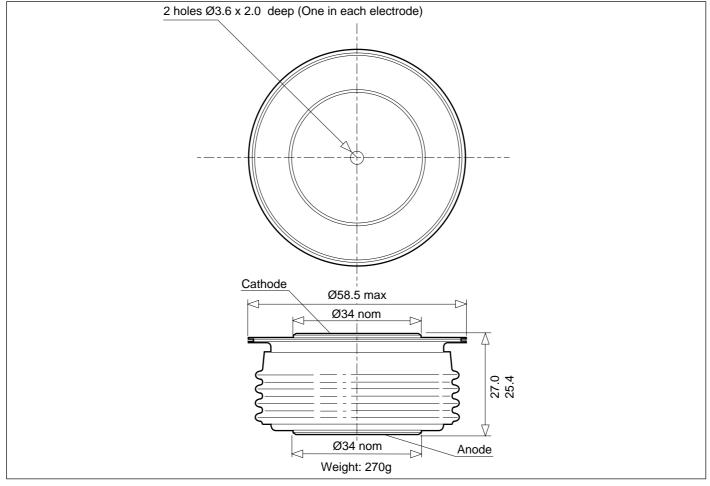


Fig. 3 Maximum (limit) transient thermal impedance - junction to case - (°CW)

PACKAGE DETAILS - M779b

(Alternative outline G includes gate connections, all other details are the same as M779b).

For further package information, please contact your local Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



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